

Three Phase Rectifier Bridge

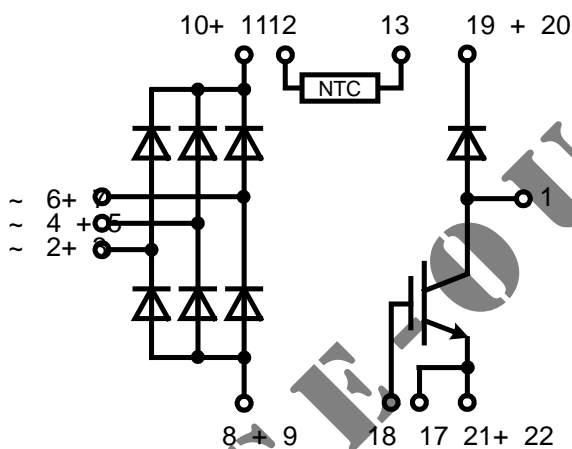
with IG BT and Fast Recovery Diode for Braking System

Rectifier Diode	Fast Recov. Diode	IG BT
$V_{RRM} = 1600\text{ V}$	$V_{CES} = 1200\text{ V}$	$V_{ES} = 1200\text{ V}$
$I_{dAVM} = 14.5\text{ A}$	$V_F = 2.76\text{ V}$	$I_{BO} = 100\text{ A}$
$I_{FSM} = 1100\text{ A}$	$I_{FSM} = 200\text{ A}$	$V_{CESAT} = 3.7\text{ V}$

Preliminary data

Part name (marking on product)

VUB 145-16NO1



E72873

Features:

- Soldering connections for PCB mounting
- Convenient package outline
- Optional NTC

Application:

- Drive Inverters with braking system

Package:

- Two functions in one package
- Easy to mount with two screws
- Suitable for wave soldering
- High temperature and power cycling capability
- UL registered, E 728 73

Recommended replacement:

VUB145-16NOXT

IG BT

			Ratin gs		
S y m b o l	Defin ition s	C on dition s	m in .	ty p .	m ax .
$V_{C E S}$	collector emitter voltage	$T_{V J} = 25\text{ }^{\circ}\text{C}$ to $150\text{ }^{\circ}\text{C}$			1200 V
$V_{G E S}$	max. DC gate voltage	contin uo u s	-20		+ 20 V
$V_{G E M}$	max. transient collector gate voltage	transient	-30		+ 30 V
$I_{C 25}$	collector current	D C $T_C = 25\text{ }^{\circ}\text{C}$			14.1 A
$I_{C 80}$		D C $T_C = 80\text{ }^{\circ}\text{C}$			100 A
P_{tot}	total power dissipation	$T_C = 25\text{ }^{\circ}\text{C}$			5.70 W
$V_{C E (sat)}$	collector emitter saturation voltage	$I_C = 15.0\text{ A}; V_G = 15\text{ V}$	$T_J = 25\text{ }^{\circ}\text{C}$		3.7 V
$V_{G E (th)}$	gate emitter threshold voltage	$I_C = 3\text{ mA}$	$T_J = 25\text{ }^{\circ}\text{C}$	4.5	6.4 5 V
$I_{C E S}$	collector emitter leakage current	$V_{C E} = V_{E S}; V_G = 0\text{ V}$ $V_{C E} = 0.8\text{ V}; V_G = 0\text{ V}$	$T_J = 25\text{ }^{\circ}\text{C}$ $T_J = 125\text{ }^{\circ}\text{C}$		0.1 mA 0.5 mA
C_{ies}	input capacitance	$V_{C E} = 25\text{ V}; V_G = 0\text{ V}; f = 1\text{ M H z}$			5.7
$t_{d(on)}$	turn-on delay time	inductive load $V_{C E} = 720\text{ V}; I_C = 75\text{ A}$ $V_G = \pm 15\text{ V}; R_G = 15\text{ }\Omega; L = 100\text{ }\mu\text{H}$	$T_J = 125\text{ }^{\circ}\text{C}$	8.0	ns
$t_{d(off)}$	turn-off delay time			68.0	ns
E_{on}	turn-on energy per pulse			9	mJ
E_{off}	turn-off energy per pulse			7.5	mJ
$I_{C M}$	reverse bias safe operating area	R B S O A $V_G = V_{\pm 15}; V_G = R 15\text{ }\Omega; L = 100\text{ }\mu\text{H}$	$T_J = 125\text{ }^{\circ}\text{C}$	15.0	A
$V_{C E K}$	short circuit safe operating area	clamp ed indu ctive load	$\leq V_{ES} \cdot di/dt$		V
t_{SC}	short circuit safe operating area	$V_{C E} = 720\text{ V}; V_G = \pm 15\text{ V};$ $R_G = 15\text{ }\Omega; \text{non-rep etitive}$	$T_J = 125\text{ }^{\circ}\text{C}$		10 μs
(S C S O A)					
RBS OA	reverse bias safe operating area	$V_{C E} = 1200\text{ V}; V_G = \pm 15\text{ V};$ $R_G = 15\text{ }\Omega; L = 100\text{ }\mu\text{H}; \text{clamp ed indu ctive load}$	$T_J = 125\text{ }^{\circ}\text{C}$		15.0 A
R_{thJC}	thermal resistance junction to case			0.22	K / W
R_{thCH}	thermal resistance case to heatsink			0.22	K / W

Fast Recovery Diode

			Ratin gs		
S y m b o l	Defin ition s	C on dition s	m in .	ty p .	m ax .
V_{RRM}	max. repetitive reverse voltage	$T_{V J} = 150\text{ }^{\circ}\text{C}$			1200 V
I_{FAV}	average forward current	rect.; $d = 0.5$	$T_C = 80\text{ }^{\circ}\text{C}$		27 A
I_{FRMS}	rms forward current	rect.; $d = 0.5$	$T_C = 80\text{ }^{\circ}\text{C}$		3.8 A
I_{FSM}	max. surge forward current	$t = 10\text{ ms}$	$T_J = 45\text{ }^{\circ}\text{C}$		200 A
P_{tot}	total power dissipation	$T_C = 25\text{ }^{\circ}\text{C}$			13.0 W
V_{F0}	threshold voltage		$T_{V J} = 150\text{ }^{\circ}\text{C}$		1.3 V
r_F	slope resistance	for p ow er loss calcu lation only			16 $\text{m}\Omega$
V_F	forward voltage	$I_F = 3.0\text{ A}$	$T_J = 25\text{ }^{\circ}\text{C}$		2.76 V
I_R	reverse current	$V_R = V_{RRM}$	$T_{V J} = 25\text{ }^{\circ}\text{C}$ $T_{V J} = 125\text{ }^{\circ}\text{C}$		0.25 mA 1 mA
I_{RM}	reverse recovery current	$I_F = 5.0\text{ A}; V_R = 100\text{ V}; di/dt = -100\text{ A}/\mu\text{s}$		5.5	11 A
t_{rr}	reverse recovery time	$I_F = 1\text{ A}; V_R = 30\text{ V}; di/dt = -200\text{ A}/\mu\text{s}$		4.0	ns
R_{thJC}	thermal resistance junction to case			0.9	K / W
R_{thCH}	thermal resistance case to heatsink			0.1	K / W

 $T_C = 25\text{ }^{\circ}\text{C}$ unless otherwise stated

Rectifier Diode

S y m b o l	C o n d i t i o n s	R a t i n g s		
		m i n .	t y p .	m a x .
V_{RRM}	max. repetitive reverse voltage	$T_{VF} = 25\text{ }^{\circ}\text{C}$		1600 V
I_R	reverse current	$V_R = V_{RRM}$ $T_{VF} = 25\text{ }^{\circ}\text{C}$ $T_{VF} = 150\text{ }^{\circ}\text{C}$		0.1 mA 2 mA
V_F	forward voltage	$I_F = 15.0\text{ A}$ $v_{TF} = 25\text{ }^{\circ}\text{C}$		1.68 V
$I_{D(AV)M}$	max. average DC output current	rectangular; $d \leq \frac{1}{3}$; b ridge $cT = 80\text{ }^{\circ}\text{C}$		14.5 A
V_{F0}	threshold voltage	$T_{VF} = 150\text{ }^{\circ}\text{C}$		0.85 V
r_F	slope resistance	for power loss calculation only		5.9 m Ω
R_{thJC}	thermal resistance junction to case	per diode $T_{VF} = 25\text{ }^{\circ}\text{C}$		0.5 K/W
R_{thCH}	thermal resistance case to heatsink	$T_{VF} = 25\text{ }^{\circ}\text{C}$		0.1 K/W
P_{tot}	total power dissipation	$T_{VF} = 25\text{ }^{\circ}\text{C}$		25.0 W
I_{FSM}	max. forward surge current	$t = 10\text{ ms (50\% duty)}$ $V_R = 0\text{ V}$ $v_{VF} = 145\text{ }^{\circ}\text{C}$ $v_{VF} = 150\text{ }^{\circ}\text{C}$		1100 A 960 A
I^2t	value for fusing	$t = 10\text{ ms (50\% duty)}$ $V_R = 0\text{ V}$ $v_{VF} = 145\text{ }^{\circ}\text{C}$ $v_{VF} = 150\text{ }^{\circ}\text{C}$		6050 A ² s 4610 A ² s

Temperature Sensor NTC

S y m b o l	D e f i n i t i o n s	C o n d i t i o n s	R a t i n g s	
			m i n .	m a x .
R_{25}	resistance	$T_C = 25\text{ }^{\circ}\text{C}$	4.75	5.25 k Ω
$B_{25/85}$			3375	K

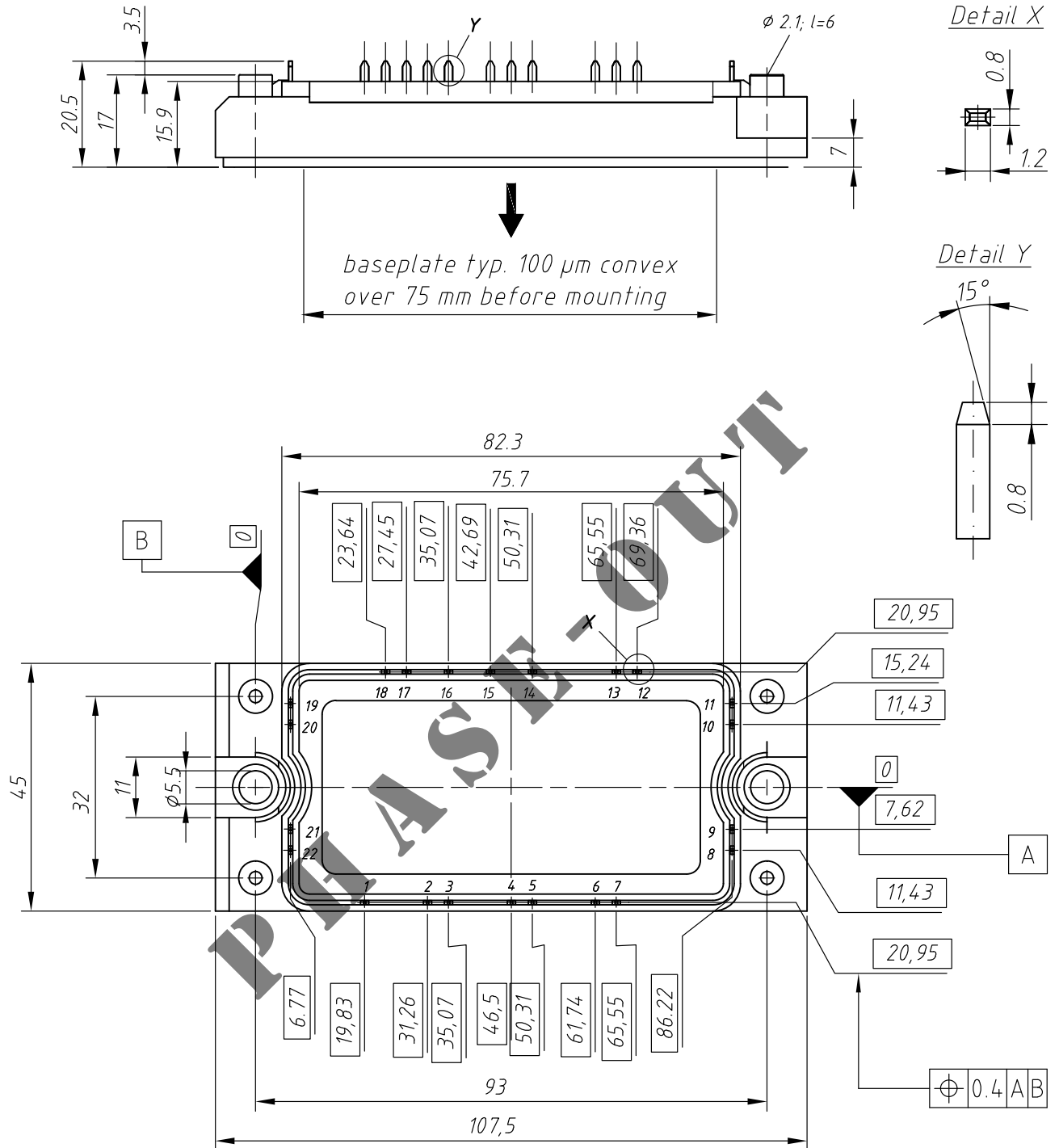
Module

S y m b o l	D e f i n i t i o n s	C o n d i t i o n s	R a t i n g s	
			m i n .	m a x .
T_{VJ}	operating temperature		-40	125 $^{\circ}\text{C}$
T_{VJM}	max. virtual junction temperature			150 $^{\circ}\text{C}$
T_{stg}	storage temperature		-40	125 $^{\circ}\text{C}$
V_{ISO}	isolation voltage	$I_{ISO} \leq 1\text{ mA}; 50/60\text{ Hz};$ $t = 1\text{ min.}$ $t = 1\text{ s}$		2500 V ~ 3000 V ~
M_d	mounting torque	(M5)	2.7	3.3 N m
d_s	creep distance on surface		12.7	mm
d_A	strike distance through air		9.6	mm
a	maximum allowable acceleration		50	m/s ²
$R_{pin-chip}$	thermal resistance pin to chip	$T_{VF} = 25\text{ }^{\circ}\text{C}$		2 Ωm
Weight				180 g

 $T_C = 25\text{ }^{\circ}\text{C}$ unless otherwise stated

Outline Drawing

Dimensions in mm (1 mm = 0.0394")



Product Marking

Ordering	Part Name	Marking on	Product Delivery Mode	Base Qty	Ordering Code
Standard	VUB 145-16N	O1 VUB	145-16N O1	Box	6 49 6669

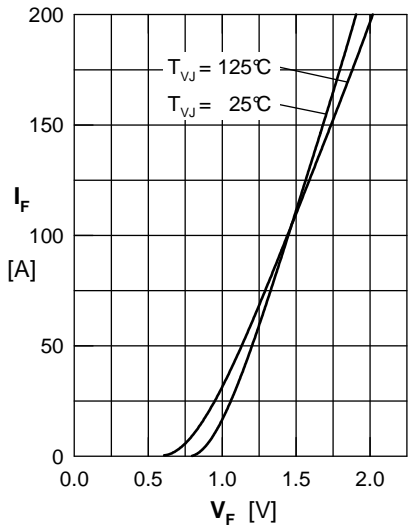


Fig. 1 Forward current vs. voltage drop per diode

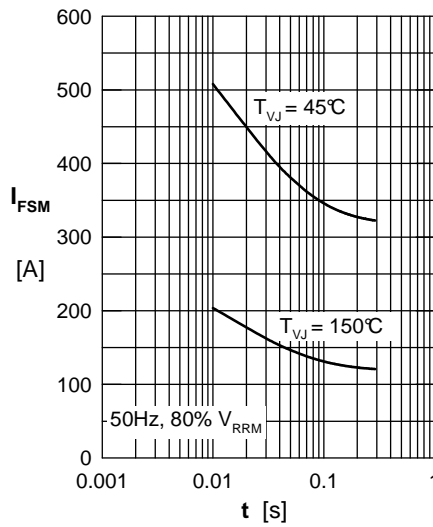


Fig. 2 Surge overload current

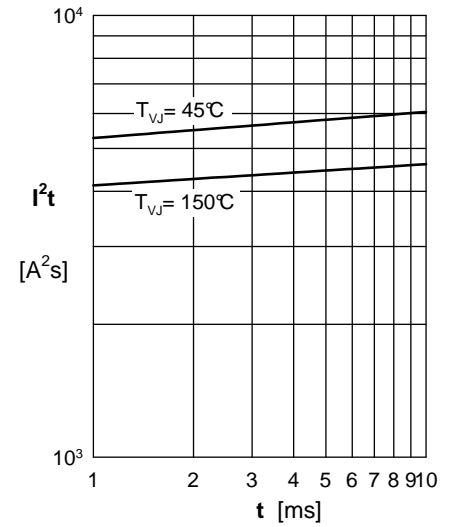


Fig. 3 I^2t versus time per diode

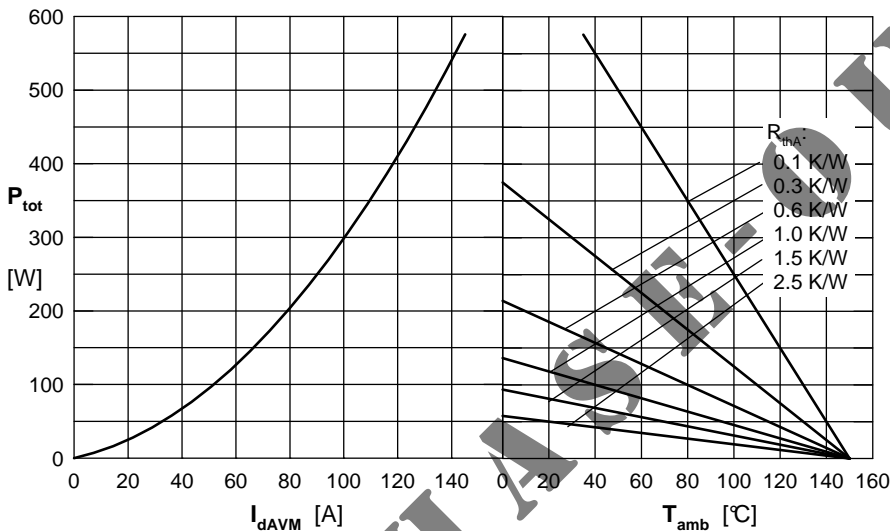


Fig. 4 Power dissipation versus direct output current and ambient temperature, sine 180°

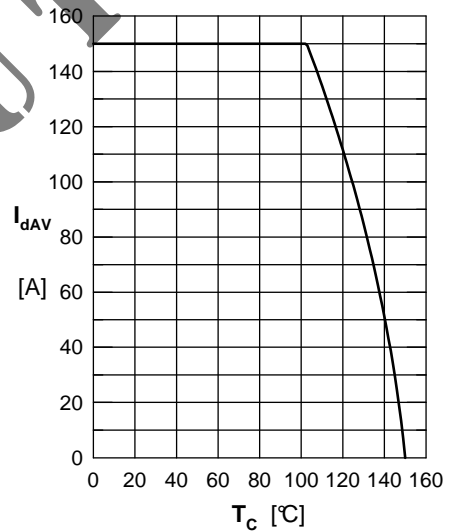


Fig. 5 Max. forward current vs. case temperature

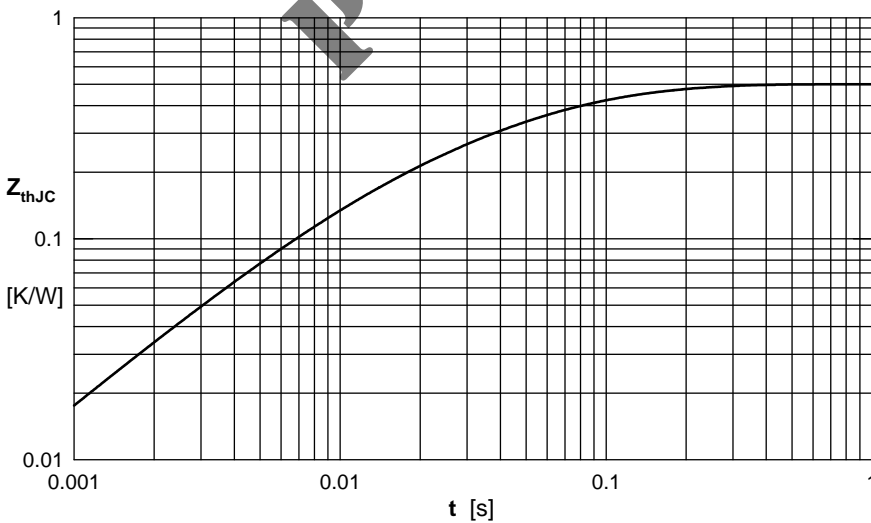


Fig. 6 Transient thermal impedance junction to case

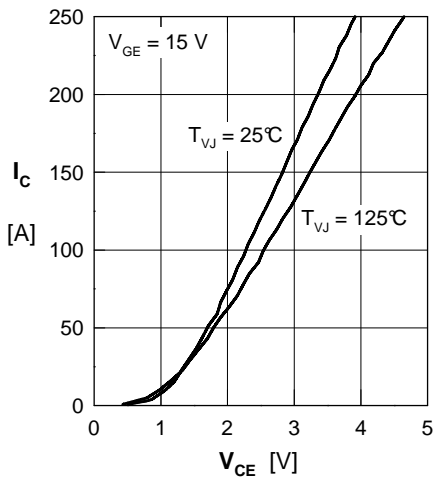


Fig. 7 Typ. output characteristics

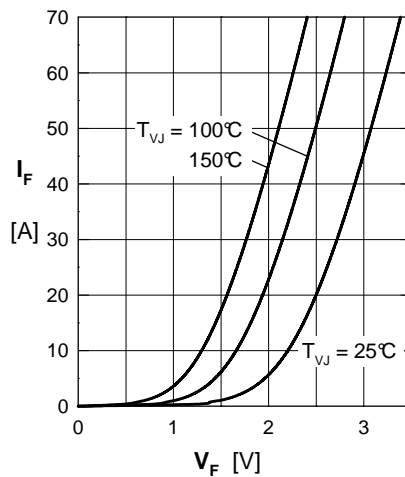


Fig. 8 Typ. forward characteristics of free wheeling diode

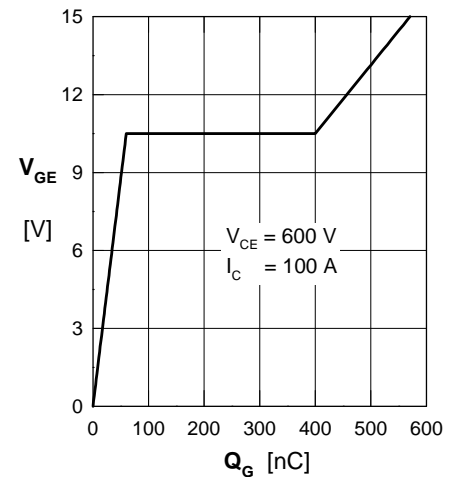


Fig. 9 Typ. turn on gate charge

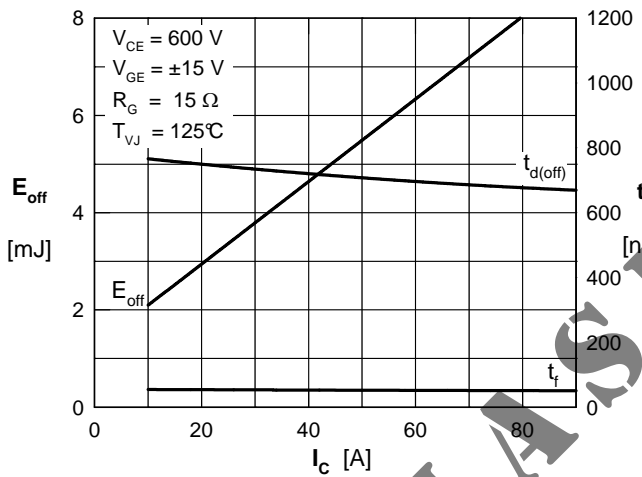


Fig. 10 Typ. turn off energy and switching times versus collector current

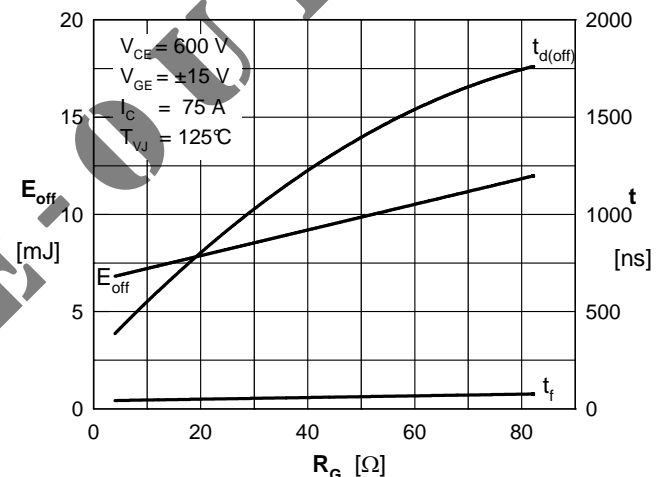


Fig. 11 Typ. turn off energy and switching times versus gate resistor

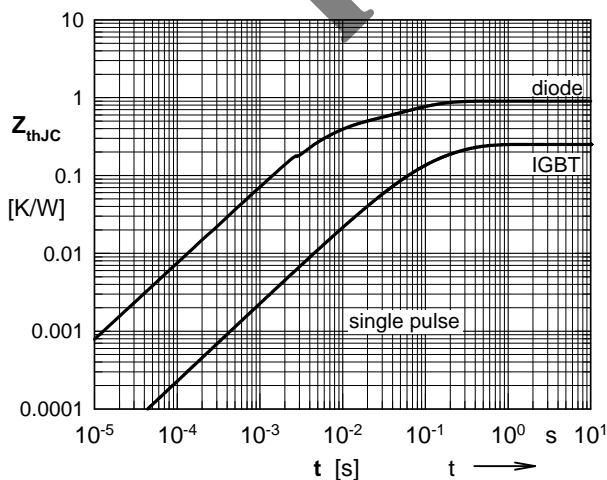


Fig. 12 Typ. transient thermal impedance

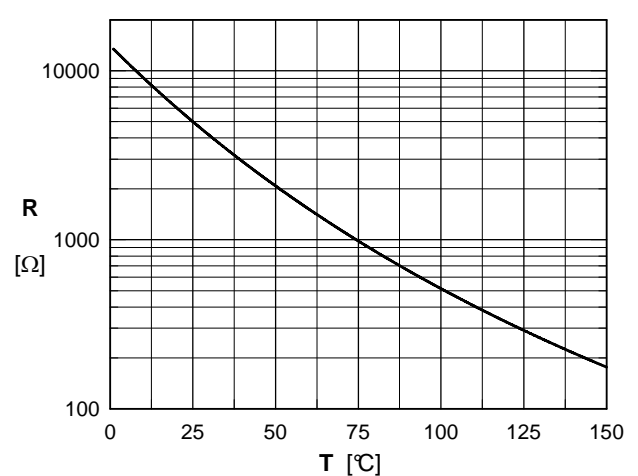


Fig. 13 Typ. thermistor resistance vs. temperature